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November 2013

SGP23N60UF 600V PT IGBT

General Description

Fairchild's UF series IGBTs provide low conduction and switching losses. UF series is designed for the applications such as general inverters and PFC where High Speed Switching is required feature.

Features

- 12 A, 600 V, T_C = 100°C
- Low Saturation Voltage: $V_{CE}(sat) = 2.1 \text{ V} @ I_{C} = 12 \text{ A}$
- High Input Impedance





Applications

General Inverter, PFC

Absolute Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Description	1	Ratings	Unit
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ $T_C = 25^{\circ}C$	23	А
I _C	Collector Current	@ T _C = 100°C	12	Α
I _{CM (1)}	Pulsed Collector Current		92	Α
P _D	Maximum Power Dissipation	@ T _C = 25°C	100	W
	Maximum Power Dissipation	@ T _C = 100°C	40	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes: (1) Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Electrical Characteristics of the IGBT To = 25°C unles

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Chai	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \text{ uA}$	600			V
ΔB _{VCES} / ΔT _J	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA		0.6		V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V		/	250	uA
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V			± 100	nA
On Char	racteristics G-E Threshold Voltage	$I_C = 12 \text{ mA}, V_{CE} = V_{GE}$	3.5	4.5	6.5	V
V _{GE(th)}	Collector to Emitter			4.5 2.1	6.5 2.6	V
V _{CE(sat)}	Saturation Voltage	$I_C = 12 \text{ A}, V_{GE} = 15 \text{ V}$ $I_C = 23 \text{ A}, V_{GE} = 15 \text{ V}$		2.6		V
Dynamic	c Characteristics					
C _{ies}	Input Capacitance	V 00 V V 0 V		720		pF
C _{oes}	Output Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$ f = 1 MHz		100		pF
C _{res}	Reverse Transfer Capacitance	=		25		pF
	ng Characteristics					
t _{d(on)}	Turn-On Delay Time			17		ns
t _r	Rise Time			27		ns

'd(on)	Tani on Belay Time	V _{CC} = 300 V, I _C = 12 A,			110
t _r	Rise Time		 27		ns
t _{d(off)}	Turn-Off Delay Time		 60	130	ns
	Fall Time	$R_G = 23 \Omega, V_{GE} = 15 V,$	 70	150	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C	 115	-	uJ
E _{off}	Turn-Off Switching Loss		 135		uJ
E _{ts}	Total Switching Loss		 250	400	uJ
t _{d(on)}	Turn-On Delay Time	$V_{CC} = 300 \text{ V, } I_{C} = 12 \text{ A,}$ $R_{G} = 23 \Omega, V_{GE} = 15 \text{ V,}$ Inductive Load, $T_{C} = 125^{\circ}\text{C}$	 23	-	ns
t _r	Rise Time		 32	-	ns
t _{d(off)}	Turn-Off Delay Time		 100	200	ns
t _f	Fall Time		 220	250	ns
E _{on}	Turn-On Switching Loss		 205		uJ
E_{off}	Turn-Off Switching Loss		 320		uJ
E _{ts}	Total Switching Loss		 525	800	uJ
	•	•			

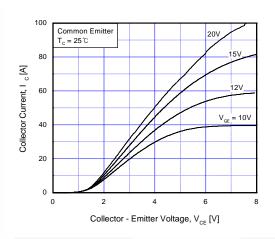


Fig 1. Typical Output Characteristics

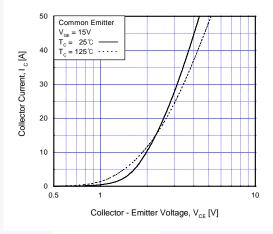


Fig 2. Typical Saturation Voltage Characteristics

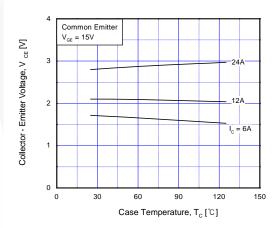


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

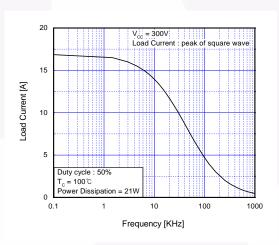


Fig 4. Load Current vs. Frequency

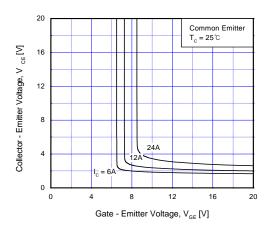


Fig 5. Saturation Voltage vs. V_{GE}

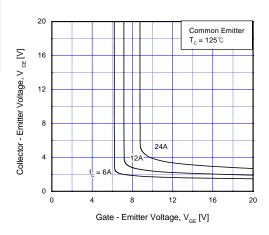


Fig 6. Saturation Voltage vs. $V_{\rm GE}$

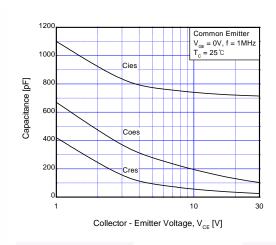


Fig 7. Capacitance Characteristics

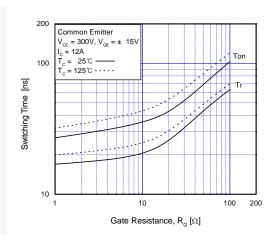


Fig 8. Turn-On Characteristics vs.
Gate Resistance

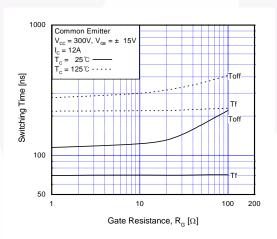


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

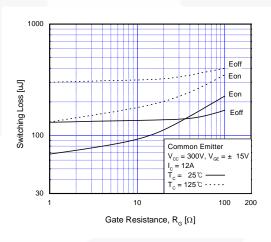


Fig 10. Switching Loss vs. Gate Resistance

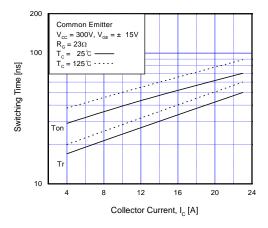


Fig 11. Turn-On Characteristics vs. Collector Current

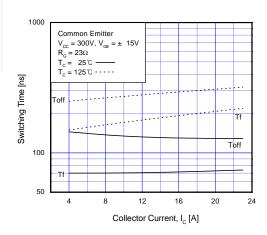
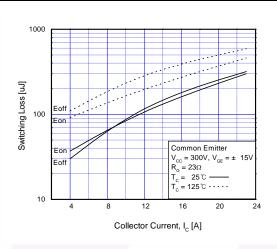


Fig 12. Turn-Off Characteristics vs. Collector Current



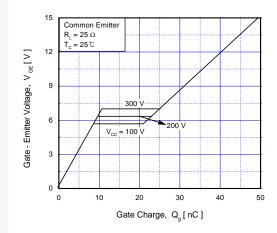
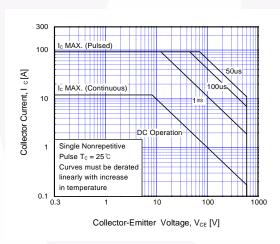


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



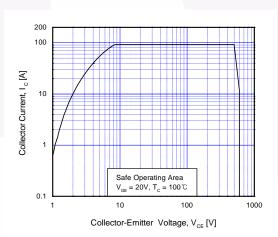


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

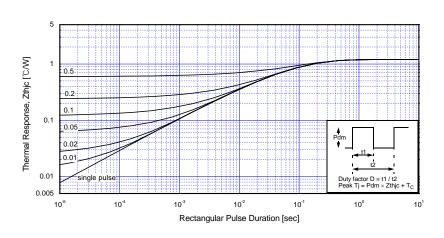


Fig 17. Transient Thermal Impedance of IGBT

Mechanical Dimensions

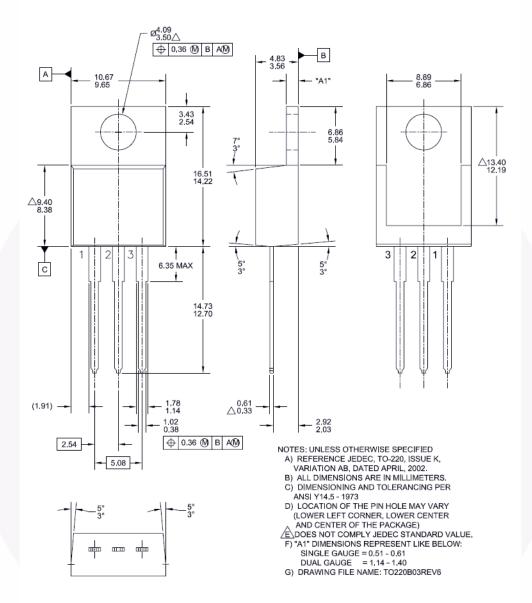


Figure 18. TO-220 3L - TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB

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